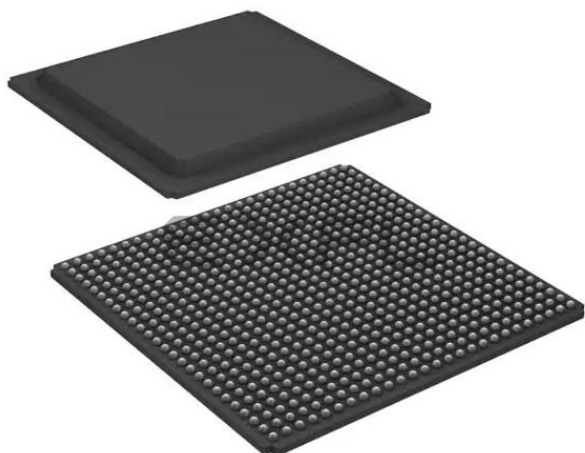




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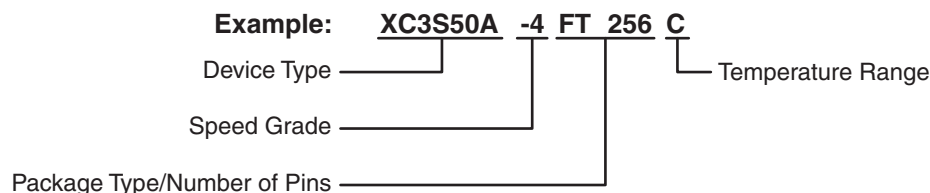
The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Active
Number of LABs/CLBs	2816
Number of Logic Elements/Cells	25344
Total RAM Bits	589824
Number of I/O	502
Number of Gates	1400000
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	676-BGA
Supplier Device Package	676-FBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc3s1400a-4fg676c

Ordering Information

Spartan-3A FPGAs are available in both standard and Pb-free packaging options for all device/package combinations. The Pb-free packages include a 'G' character in the ordering code.



DS529-1_05_011309

Device	Speed Grade		Package Type / Number of Pins ⁽¹⁾		Temperature Range (T _J)	
XC3S50A	-4	Standard Performance	VQ100/ VQG100	100-pin Very Thin Quad Flat Pack (VQFP)	C	Commercial (0°C to 85°C)
XC3S200A	-5	High Performance (Commercial only)	TQ144/ TQG144	144-pin Thin Quad Flat Pack (TQFP)	I	Industrial (–40°C to 100°C)
XC3S400A			FT256/ FTG256	256-ball Fine-Pitch Thin Ball Grid Array (FTBGA)		
XC3S700A			FG320/ FGG320	320-ball Fine-Pitch Ball Grid Array (FBGA)		
XC3S1400A			FG400/ FGG400	400-ball Fine-Pitch Ball Grid Array (FBGA)		
			FG484/ FGG484	484-ball Fine-Pitch Ball Grid Array (FBGA)		
			FG676/ FGG676	676-ball Fine-Pitch Ball Grid Array (FBGA)		

Notes:

- See [Table 2](#) for specific device/package combinations.
- See [DS681](#) for the XA Automotive Spartan-3A FPGAs.

Revision History

The following table shows the revision history for this document.

Date	Version	Revision
12/05/06	1.0	Initial release.
02/02/07	1.1	Promoted to Preliminary status. Updated maximum differential I/O count for XC3S50A in Table 1 . Updated differential input-only pin counts in Table 2 .
03/16/07	1.2	Minor formatting updates.
04/23/07	1.3	Added " Production Status " section.
05/08/07	1.4	Updated XC3S400A to Production.
07/10/07	1.4.1	Minor updates.
04/15/08	1.6	Added VQ100 for XC3S50A and XC3S200A and extended FT256 to XC3S700A and XC3S1400A. Added reference to SCD 4103 for 750 Mbps performance.
05/28/08	1.7	Added reference to XA Automotive version.
03/06/09	1.8	Simplified Ordering Information. Added references to Extended Spartan-3A Family. Removed reference to SCD 4103.
08/19/10	2.0	Updated Table 2 to clarify TQ/VQ size.

Input Setup and Hold Times

Table 20: Setup and Hold Times for the IOB Input Path

Symbol	Description	Conditions	IFD_ DELAY_ VALUE	Device	Speed Grade		Units
					-5	-4	
					Min	Min	
Setup Times							
T _{IO PICK}	Time from the setup of data at the Input pin to the active transition at the ICLK input of the Input Flip-Flop (IFF). No Input Delay is programmed.	LVCMOS25 ⁽²⁾	0	XC3S50A	1.56	1.58	ns
				XC3S200A	1.71	1.81	ns
				XC3S400A	1.30	1.51	ns
				XC3S700A	1.34	1.51	ns
				XC3S1400A	1.36	1.74	ns
T _{IO PICKD}	Time from the setup of data at the Input pin to the active transition at the ICLK input of the Input Flip-Flop (IFF). The Input Delay is programmed.	LVCMOS25 ⁽²⁾	1	XC3S50A	2.16	2.18	ns
			2		3.10	3.12	ns
			3		3.51	3.76	ns
			4		4.04	4.32	ns
			5		3.88	4.24	ns
			6		4.72	5.09	ns
			7		5.47	5.94	ns
			8		5.97	6.52	ns
			1	XC3S200A	2.05	2.20	ns
			2		2.72	2.93	ns
			3		3.38	3.78	ns
			4		3.88	4.37	ns
			5		3.69	4.20	ns
			6		4.56	5.23	ns
			7		5.34	6.11	ns
			8		5.85	6.71	ns
			1	XC3S400A	1.79	2.02	ns
			2		2.43	2.67	ns
			3		3.02	3.43	ns
			4		3.49	3.96	ns
			5		3.41	3.95	ns
			6		4.20	4.81	ns
			7		4.96	5.66	ns
			8		5.44	6.19	ns

Table 22: Propagation Times for the IOB Input Path(Continued)

Symbol	Description	Conditions	DELAY_VALUE	Device	Speed Grade		Units
					-5	-4	
					Max	Max	
T _{IOPLID}	The time it takes for data to travel from the Input pin through the IFF latch to the I output with the input delay programmed	LVCMOS25 ⁽²⁾	5	XC3S400A	3.55	4.18	ns
			6		4.34	5.03	ns
			7		5.09	5.88	ns
			8		5.58	6.42	ns
			1	XC3S700A	1.96	2.18	ns
			2		2.76	3.06	ns
			3		3.45	3.95	ns
			4		3.97	4.54	ns
			5		3.83	4.37	ns
			6		4.74	5.42	ns
			7		5.53	6.33	ns
			8		6.06	6.96	ns
			1	XC3S1400A	1.93	2.40	ns
			2		2.69	3.15	ns
			3		3.52	3.99	ns
			4		3.89	4.55	ns
			5		3.95	4.42	ns
			6		4.53	5.32	ns
			7		5.30	6.21	ns
			8		5.83	6.80	ns

Notes:

1. The numbers in this table are tested using the methodology presented in [Table 27](#) and are based on the operating conditions set forth in [Table 8](#) and [Table 11](#).
2. This propagation time requires adjustment whenever a signal standard other than LVCMOS25 is assigned to the data Input. When this is true, *add* the appropriate Input adjustment from [Table 23](#).

Table 26: Output Timing Adjustments for IOB(Continued)

Convert Output Time from LVCMOS25 with 12mA Drive and Fast Slew Rate to the Following Signal Standard (IOSTANDARD)			Add the Adjustment Below		Units
			Speed Grade		
			-5	-4	
LVCMOS25	Slow	2 mA	5.33	5.33	ns
		4 mA	2.81	2.81	ns
		6 mA	2.82	2.82	ns
		8 mA	1.14	1.14	ns
		12 mA	1.10	1.10	ns
		16 mA	0.83	0.83	ns
		24 mA	2.26 ⁽³⁾	2.26 ⁽³⁾	ns
	Fast	2 mA	4.36	4.36	ns
		4 mA	1.76	1.76	ns
		6 mA	1.25	1.25	ns
		8 mA	0.38	0.38	ns
		12 mA	0	0	ns
		16 mA	0.01	0.01	ns
		24 mA	0.01	0.01	ns
	QuietIO	2 mA	25.92	25.92	ns
		4 mA	25.92	25.92	ns
		6 mA	25.92	25.92	ns
		8 mA	15.57	15.57	ns
		12 mA	15.59	15.59	ns
		16 mA	14.27	14.27	ns
		24 mA	11.37	11.37	ns
LVCMOS18	Slow	2 mA	4.48	4.48	ns
		4 mA	3.69	3.69	ns
		6 mA	2.91	2.91	ns
		8 mA	1.99	1.99	ns
		12 mA	1.57	1.57	ns
		16 mA	1.19	1.19	ns
	Fast	2 mA	3.96	3.96	ns
		4 mA	2.57	2.57	ns
		6 mA	1.90	1.90	ns
		8 mA	1.06	1.06	ns
		12 mA	0.83	0.83	ns
		16 mA	0.63	0.63	ns
	QuietIO	2 mA	24.97	24.97	ns
		4 mA	24.97	24.97	ns
		6 mA	24.08	24.08	ns
		8 mA	16.43	16.43	ns
12 mA		14.52	14.52	ns	
		16 mA	13.41	13.41	ns

Table 26: Output Timing Adjustments for IOB(Continued)

Convert Output Time from LVCMOS25 with 12mA Drive and Fast Slew Rate to the Following Signal Standard (IOSTANDARD)			Add the Adjustment Below		Units
			Speed Grade		
			-5	-4	
LVCMOS15	Slow	2 mA	5.82	5.82	ns
		4 mA	3.97	3.97	ns
		6 mA	3.21	3.21	ns
		8 mA	2.53	2.53	ns
		12 mA	2.06	2.06	ns
	Fast	2 mA	5.23	5.23	ns
		4 mA	3.05	3.05	ns
		6 mA	1.95	1.95	ns
		8 mA	1.60	1.60	ns
		12 mA	1.30	1.30	ns
	QuietIO	2 mA	34.11	34.11	ns
		4 mA	25.66	25.66	ns
		6 mA	24.64	24.64	ns
		8 mA	22.06	22.06	ns
		12 mA	20.64	20.64	ns
LVCMOS12	Slow	2 mA	7.14	7.14	ns
		4 mA	4.87	4.87	ns
		6 mA	5.67	5.67	ns
	Fast	2 mA	6.77	6.77	ns
		4 mA	5.02	5.02	ns
		6 mA	4.09	4.09	ns
	QuietIO	2 mA	50.76	50.76	ns
		4 mA	43.17	43.17	ns
		6 mA	37.31	37.31	ns
PCI33_3			0.34	0.34	ns
PCI66_3			0.34	0.34	ns
HSTL_I			0.78	0.78	ns
HSTL_III			1.16	1.16	ns
HSTL_I_18			0.35	0.35	ns
HSTL_II_18			0.30	0.30	ns
HSTL_III_18			0.47	0.47	ns
SSTL18_I			0.40	0.40	ns
SSTL18_II			0.30	0.30	ns
SSTL2_I			0	0	ns
SSTL2_II			−0.05	−0.05	ns
SSTL3_I			0	0	ns
SSTL3_II			0.17	0.17	ns

Table 26: Output Timing Adjustments for IOB(Continued)

Convert Output Time from LVCMOS25 with 12mA Drive and Fast Slew Rate to the Following Signal Standard (IOSTANDARD)	Add the Adjustment Below		Units
	Speed Grade		
	-5	-4	
Differential Standards			
LVDS_25	1.16	1.16	ns
LVDS_33	0.46	0.46	ns
BLVDS_25	0.11	0.11	ns
MINI_LVDS_25	0.75	0.75	ns
MINI_LVDS_33	0.40	0.40	ns
LVPECL_25	Input Only		
LVPECL_33			
RSDS_25	1.42	1.42	ns
RSDS_33	0.58	0.58	ns
TMDS_33	0.46	0.46	ns
PPDS_25	1.07	1.07	ns
PPDS_33	0.63	0.63	ns
DIFF_HSTL_I_18	0.43	0.43	ns
DIFF_HSTL_II_18	0.41	0.41	ns
DIFF_HSTL_III_18	0.36	0.36	ns
DIFF_HSTL_I	1.01	1.01	ns
DIFF_HSTL_III	0.54	0.54	ns
DIFF_SSTL18_I	0.49	0.49	ns
DIFF_SSTL18_II	0.41	0.41	ns
DIFF_SSTL2_I	0.82	0.82	ns
DIFF_SSTL2_II	0.09	0.09	ns
DIFF_SSTL3_I	1.16	1.16	ns
DIFF_SSTL3_II	0.28	0.28	ns

Notes:

1. The numbers in this table are tested using the methodology presented in [Table 27](#) and are based on the operating conditions set forth in [Table 8](#), [Table 11](#), and [Table 13](#).
2. These adjustments are used to convert output- and three-state-path times originally specified for the LVCMOS25 standard with 12 mA drive and Fast slew rate to times that correspond to other signal standards. Do not adjust times that measure when outputs go into a high-impedance state.
3. Note that 16 mA drive is faster than 24 mA drive for the Slow slew rate.

Table 31: CLB Distributed RAM Switching Characteristics

Symbol	Description	-5		-4		Units
		Min	Max	Min	Max	
Clock-to-Output Times						
T _{SHCKO}	Time from the active edge at the CLK input to data appearing on the distributed RAM output	–	1.69	–	2.01	ns
Setup Times						
T _{DS}	Setup time of data at the BX or BY input before the active transition at the CLK input of the distributed RAM	–0.07	–	–0.02	–	ns
T _{AS}	Setup time of the F/G address inputs before the active transition at the CLK input of the distributed RAM	0.18	–	0.36	–	ns
T _{WS}	Setup time of the write enable input before the active transition at the CLK input of the distributed RAM	0.30	–	0.59	–	ns
Hold Times						
T _{DH}	Hold time of the BX and BY data inputs after the active transition at the CLK input of the distributed RAM	0.13	–	0.13	–	ns
T _{AH} , T _{WH}	Hold time of the F/G address inputs or the write enable input after the active transition at the CLK input of the distributed RAM	0.01	–	0.01	–	ns
Clock Pulse Width						
T _{WPH} , T _{WPL}	Minimum High or Low pulse width at CLK input	0.88	–	1.01	–	ns

Notes:

1. The numbers in this table are based on the operating conditions set forth in [Table 8](#).

Table 32: CLB Shift Register Switching Characteristics

Symbol	Description	-5		-4		Units
		Min	Max	Min	Max	
Clock-to-Output Times						
T _{REG}	Time from the active edge at the CLK input to data appearing on the shift register output	–	4.11	–	4.82	ns
Setup Times						
T _{SRLDS}	Setup time of data at the BX or BY input before the active transition at the CLK input of the shift register	0.13	–	0.18	–	ns
Hold Times						
T _{SRLDH}	Hold time of the BX or BY data input after the active transition at the CLK input of the shift register	0.16	–	0.16	–	ns
Clock Pulse Width						
T _{WPH} , T _{WPL}	Minimum High or Low pulse width at CLK input	0.90	–	1.01	–	ns

Notes:

1. The numbers in this table are based on the operating conditions set forth in [Table 8](#).

18 x 18 Embedded Multiplier Timing

Table 34: 18 x 18 Embedded Multiplier Timing

Symbol	Description	Speed Grade				Units
		-5		-4		
		Min	Max	Min	Max	
Combinatorial Delay						
T _{MULT}	Combinational multiplier propagation delay from the A and B inputs to the P outputs, assuming 18-bit inputs and a 36-bit product (AREG, BREG, and PREG registers unused)	–	4.36	–	4.88	ns
Clock-to-Output Times						
T _{MSCKP_P}	Clock-to-output delay from the active transition of the CLK input to valid data appearing on the P outputs when using the PREG register ^(2,3)	–	0.84	–	1.30	ns
T _{MSCKP_A} T _{MSCKP_B}	Clock-to-output delay from the active transition of the CLK input to valid data appearing on the P outputs when using either the AREG or BREG register ^(2,4)	–	4.44	–	4.97	ns
Setup Times						
T _{MSDCK_P}	Data setup time at the A or B input before the active transition at the CLK when using only the PREG output register (AREG, BREG registers unused) ⁽³⁾	3.56	–	3.98	–	ns
T _{MSDCK_A}	Data setup time at the A input before the active transition at the CLK when using the AREG input register ⁽⁴⁾	0.00	–	0.00	–	ns
T _{MSDCK_B}	Data setup time at the B input before the active transition at the CLK when using the BREG input register ⁽⁴⁾	0.00	–	0.00	–	ns
Hold Times						
T _{MSCKD_P}	Data hold time at the A or B input after the active transition at the CLK when using only the PREG output register (AREG, BREG registers unused) ⁽³⁾	0.00	–	0.00	–	ns
T _{MSCKD_A}	Data hold time at the A input after the active transition at the CLK when using the AREG input register ⁽⁴⁾	0.35	–	0.45	–	ns
T _{MSCKD_B}	Data hold time at the B input after the active transition at the CLK when using the BREG input register ⁽⁴⁾	0.35	–	0.45	–	ns
Clock Frequency						
F _{MULT}	Internal operating frequency for a two-stage 18x18 multiplier using the AREG and BREG input registers and the PREG output register ⁽¹⁾	0	280	0	250	MHz

Notes:

1. Combinational delay is less and pipelined performance is higher when multiplying input data with less than 18 bits.
2. The PREG register is typically used in both single-stage and two-stage pipelined multiplier implementations.
3. The PREG register is typically used when inferring a single-stage multiplier.
4. Input registers AREG or BREG are typically used when inferring a two-stage multiplier.
5. The numbers in this table are based on the operating conditions set forth in [Table 8](#).

Block RAM Timing

Table 35: Block RAM Timing

Symbol	Description	Speed Grade				Units
		-5		-4		
		Min	Max	Min	Max	
Clock-to-Output Times						
T _{RCKO}	When reading from block RAM, the delay from the active transition at the CLK input to data appearing at the DOUT output	–	2.06	–	2.49	ns
Setup Times						
T _{RCKK_ADDR}	Setup time for the ADDR inputs before the active transition at the CLK input of the block RAM	0.32	–	0.36	–	ns
T _{RDCK_DIB}	Setup time for data at the DIN inputs before the active transition at the CLK input of the block RAM	0.28	–	0.31	–	ns
T _{RCKK_ENB}	Setup time for the EN input before the active transition at the CLK input of the block RAM	0.69	–	0.77	–	ns
T _{RCKK_WEB}	Setup time for the WE input before the active transition at the CLK input of the block RAM	1.12	–	1.26	–	ns
Hold Times						
T _{RCKC_ADDR}	Hold time on the ADDR inputs after the active transition at the CLK input	0	–	0	–	ns
T _{RCKD_DIB}	Hold time on the DIN inputs after the active transition at the CLK input	0	–	0	–	ns
T _{RCKC_ENB}	Hold time on the EN input after the active transition at the CLK input	0	–	0	–	ns
T _{RCKC_WEB}	Hold time on the WE input after the active transition at the CLK input	0	–	0	–	ns
Clock Timing						
T _{BPWH}	High pulse width of the CLK signal	1.56	–	1.79	–	ns
T _{BPWL}	Low pulse width of the CLK signal	1.56	–	1.79	–	ns
Clock Frequency						
F _{BRAM}	Block RAM clock frequency	0	320	0	280	MHz

Notes:

1. The numbers in this table are based on the operating conditions set forth in [Table 8](#).

Table 37: Switching Characteristics for the DLL

Symbol	Description	Device	Speed Grade				Units	
			-5		-4			
			Min	Max	Min	Max		
Output Frequency Ranges								
CLKOUT_FREQ_CLK0	Frequency for the CLK0 and CLK180 outputs	All	5	280	5	250	MHz	
CLKOUT_FREQ_CLK90	Frequency for the CLK90 and CLK270 outputs		5	200	5	200	MHz	
CLKOUT_FREQ_2X	Frequency for the CLK2X and CLK2X180 outputs		10	334	10	334	MHz	
CLKOUT_FREQ_DV	Frequency for the CLKDV output		0.3125	186	0.3125	166	MHz	
Output Clock Jitter ^(2,3,4)								
CLKOUT_PER_JITT_0	Period jitter at the CLK0 output	All	—	±100	—	±100	ps	
CLKOUT_PER_JITT_90	Period jitter at the CLK90 output		—	±150	—	±150	ps	
CLKOUT_PER_JITT_180	Period jitter at the CLK180 output		—	±150	—	±150	ps	
CLKOUT_PER_JITT_270	Period jitter at the CLK270 output		—	±150	—	±150	ps	
CLKOUT_PER_JITT_2X	Period jitter at the CLK2X and CLK2X180 outputs		—	±[0.5% of CLKIN period + 100]	—	±[0.5% of CLKIN period + 100]	ps	
CLKOUT_PER_JITT_DV1	Period jitter at the CLKDV output when performing integer division		—	±150	—	±150	ps	
CLKOUT_PER_JITT_DV2	Period jitter at the CLKDV output when performing non-integer division		—	±[0.5% of CLKIN period + 100]	—	±[0.5% of CLKIN period + 100]	ps	
Duty Cycle ⁽⁴⁾								
CLKOUT_DUTY_CYCLE_DLL	Duty cycle variation for the CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV outputs, including the BUFGMUX and clock tree duty-cycle distortion	All	—	±[1% of CLKIN period + 350]	—	±[1% of CLKIN period + 350]	ps	
Phase Alignment ⁽⁴⁾								
CLKIN_CLKFB_PHASE	Phase offset between the CLKIN and CLKFB inputs	All	—	±150	—	±150	ps	
CLKOUT_PHASE_DLL	Phase offset between DLL outputs		CLK0 to CLK2X (not CLK2X180)	—	±[1% of CLKIN period + 100]	—	±[1% of CLKIN period + 100]	ps
			All others	—	±[1% of CLKIN period + 150]	—	±[1% of CLKIN period + 150]	ps
Lock Time								
LOCK_DLL ⁽³⁾	When using the DLL alone: The time from deassertion at the DCM's Reset input to the rising transition at its LOCKED output. When the DCM is locked, the CLKIN and CLKFB signals are in phase	5 MHz ≤ F _{CLKIN} ≤ 15 MHz	All	—	5	—	5	ms
		F _{CLKIN} > 15 MHz		—	600	—	600	μs
Delay Lines								
DCM_DELAY_STEP ⁽⁵⁾	Finest delay resolution, averaged over all steps	All	15	35	15	35	ps	

Notes:

1. The numbers in this table are based on the operating conditions set forth in Table 8 and Table 36.
2. Indicates the maximum amount of output jitter that the DCM adds to the jitter on the CLKIN input.
3. For optimal jitter tolerance and faster lock time, use the CLKIN_PERIOD attribute.
4. Some jitter and duty-cycle specifications include 1% of input clock period or 0.01 UI. For example, the data sheet specifies a maximum jitter of "±[1% of CLKIN period + 150]". Assume the CLKIN frequency is 100 MHz. The equivalent CLKIN period is 10 ns and 1% of 10 ns is 0.1 ns or 100 ps. According to the data sheet, the maximum jitter is ±[100 ps + 150 ps] = ±250ps.
5. The typical delay step size is 23 ps.

Miscellaneous DCM Timing

Table 42: Miscellaneous DCM Timing

Symbol	Description	Min	Max	Units
DCM_RST_PW_MIN	Minimum duration of a RST pulse width	3	—	CLKIN cycles
DCM_RST_PW_MAX ⁽²⁾	Maximum duration of a RST pulse width	N/A	N/A	seconds
		N/A	N/A	seconds
DCM_CONFIG_LAG_TIME ⁽³⁾	Maximum duration from V_{CCINT} applied to FPGA configuration successfully completed (DONE pin goes High) and clocks applied to DCM DLL	N/A	N/A	minutes
		N/A	N/A	minutes

Notes:

1. This limit only applies to applications that use the DCM DLL outputs (CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV). The DCM DFS outputs (CLKFX, CLKFX180) are unaffected.
2. This specification is equivalent to the Virtex®-4 DCM_RESET specification. This specification does not apply for Spartan-3A FPGAs.
3. This specification is equivalent to the Virtex-4 TCONFIG specification. This specification does not apply for Spartan-3A FPGAs.

DNA Port Timing

Table 43: DNA_PORT Interface Timing

Symbol	Description	Min	Max	Units
T_{DNASSU}	Setup time on SHIFT before the rising edge of CLK	1.0	—	ns
T_{DNASH}	Hold time on SHIFT after the rising edge of CLK	0.5	—	ns
T_{DNADSU}	Setup time on DIN before the rising edge of CLK	1.0	—	ns
T_{DNADH}	Hold time on DIN after the rising edge of CLK	0.5	—	ns
T_{DNARSU}	Setup time on READ before the rising edge of CLK	5.0	10,000	ns
T_{DNARH}	Hold time on READ after the rising edge of CLK	0	—	ns
$T_{DNADCKO}$	Clock-to-output delay on DOUT after rising edge of CLK	0.5	1.5	ns
$T_{DNACLKF}$	CLK frequency	0	100	MHz
$T_{DNACLKH}$	CLK High time	1.0	∞	ns
$T_{DNACLKL}$	CLK Low time	1.0	∞	ns

Notes:

1. The minimum READ pulse width is 5 ns, the maximum READ pulse width is 10 μ s.
2. The numbers in this table are based on the operating conditions set forth in Table 8.

Table 57: Types of Pins on Spartan-3A FPGAs(Continued)

Type / Color Code	Description	Pin Name(s) in Type
PWR MGMT	Control and status pins for the power-saving Suspend mode. SUSPEND is a dedicated pin and is powered by V _{CCAUX} . AWAKE is a dual-purpose pin. Unless Suspend mode is enabled in the application, AWAKE is available as a user-I/O pin.	SUSPEND, AWAKE
JTAG	Dedicated JTAG pin - 4 per device. Not available as a user-I/O pin. Every package has four dedicated JTAG pins. These pins are powered by V _{CCAUX} .	TDI, TMS, TCK, TDO
GND	Dedicated ground pin. The number of GND pins depends on the package used. All must be connected.	GND
VCCAUX	Dedicated auxiliary power supply pin. The number of VCCAUX pins depends on the package used. All must be connected. V _{CCAUX} can be either 2.5V or 3.3V. Set on board and using CONFIG VCCAUX constraint.	VCCAUX
VCCINT	Dedicated internal core logic power supply pin. The number of VCCINT pins depends on the package used. All must be connected to +1.2V.	VCCINT
VCCO	Along with all the other VCCO pins in the same bank, this pin supplies power to the output buffers within the I/O bank and sets the input threshold voltage for some I/O standards. All must be connected.	VCCO_#
N.C.	This package pin is not connected in this specific device/package combination but may be connected in larger devices in the same package.	N.C.

Notes:

1. # = I/O bank number, an integer between 0 and 3.

Package Pins by Type

Each package has three separate voltage supply inputs—VCCINT, VCCAUX, and VCCO—and a common ground return, GND. The numbers of pins dedicated to these functions vary by package, as shown in [Table 58](#).

Table 58: Power and Ground Supply Pins by Package

Package	VCCINT	VCCAUX	VCCO	GND
VQ100	4	3	6	13
TQ144	4	4	8	13
FT256 (50A/200A/400A)	6	4	16	28
FT256 (700A/1400A)	15	10	13	50
FG320	6	8	16	32
FG400	9	8	22	43
FG484	15	10	24	53
FG676	23	14	36	77

A majority of package pins are user-defined I/O or input pins. However, the numbers and characteristics of these I/O depend on the device type and the package in which it is available, as shown in [Table 59](#). The table shows the maximum number of single-ended I/O pins available, assuming that all I/O-, INPUT-, DUAL-, VREF-, and CLK-type pins are used as general-purpose I/O. AWAKE is counted here as a dual-purpose I/O pin. Likewise, the table shows the maximum number of differential pin-pairs available on the package. Finally, the table shows how the total maximum user-I/Os are distributed by pin type, including the number of unconnected—N.C.—pins on the device.

Not all I/O standards are supported on all I/O banks. The left and right banks (I/O banks 1 and 3) support higher output drive current than the top and bottom banks (I/O banks 0 and 2). Similarly, true differential output standards, such as LVDS, RSFS, PPDS, miniLVDS, and TMDS, are only supported in the top or bottom banks (I/O banks 0 and 2). Inputs are unrestricted. For more details, see the chapter “Using I/O Resources” in [UG331](#).

Table 63: Spartan-3A VQ100 Pinout(Continued)

2	IO_L12P_2/D1 (3S50A) IO_L11N_2/D1 (3S200A)	P52	DUAL
2	IP_2/VREF_2	P39	VREF
2	VCCO_2	P26	VCCO
2	VCCO_2	P45	VCCO
3	IO_L01N_3	P4	IO
3	IO_L01P_3	P3	IO
3	IO_L02N_3	P6	IO
3	IO_L02P_3	P5	IO
3	IO_L03N_3/LHCLK1	P10	CLK
3	IO_L03P_3/LHCLK0	P9	CLK
3	IO_L04N_3/IRDY2/LHCLK3	P13	CLK
3	IO_L04P_3/LHCLK2	P12	CLK
3	IO_L05N_3/LHCLK7	P16	CLK
3	IO_L05P_3/TRDY2/LHCLK6	P15	CLK
3	IO_L06N_3	P20	IO
3	IO_L06P_3	P19	IO
3	IP_3	P21	IP
3	IP_3/VREF_3	P7	VREF
3	VCCO_3	P11	VCCO
GND	GND	P14	GND
GND	GND	P18	GND
GND	GND	P42	GND
GND	GND	P47	GND
GND	GND	P58	GND
GND	GND	P63	GND
GND	GND	P69	GND
GND	GND	P74	GND
GND	GND	P8	GND
GND	GND	P80	GND
GND	GND	P87	GND
GND	GND	P91	GND
GND	GND	P95	GND
VCCAUX	DONE	P54	CONFIG
VCCAUX	PROG_B	P100	CONFIG
VCCAUX	TCK	P76	JTAG
VCCAUX	TDI	P2	JTAG
VCCAUX	TDO	P75	JTAG
VCCAUX	TMS	P1	JTAG
VCCAUX	VCCAUX	P22	VCCAUX
VCCAUX	VCCAUX	P55	VCCAUX
VCCAUX	VCCAUX	P92	VCCAUX

Table 63: Spartan-3A VQ100 Pinout(Continued)

VCCINT	VCCINT	P17	VCCINT
VCCINT	VCCINT	P38	VCCINT
VCCINT	VCCINT	P66	VCCINT
VCCINT	VCCINT	P81	VCCINT

Table 69: Spartan-3A FT256 Pinout (XC3S700A,

Bank	XC3S700A XC3S1400A	FT256 Ball	Type
1	IO_L20P_1/A18	E14	DUAL
1	IO_L22N_1/A21	D15	DUAL
1	IO_L22P_1/A20	D16	DUAL
1	IO_L23N_1/A23	D14	DUAL
1	IO_L23P_1/A22	E13	DUAL
1	IO_L24N_1/A25	C15	DUAL
1	IO_L24P_1/A24	C16	DUAL
1	IP_1/VREF_1	H12	VREF
1	IP_1/VREF_1	J14	VREF
1	IP_1/VREF_1	M13	VREF
1	IP_1/VREF_1	M14	VREF
1	VCCO_1	E15	VCCO
1	VCCO_1	J15	VCCO
1	VCCO_1	N15	VCCO
2	IO_L01N_2/M0	P4	DUAL
2	IO_L01P_2/M1	N4	DUAL
2	IO_L02N_2/CSO_B	T2	DUAL
2	IO_L02P_2/M2	R2	DUAL
2	IO_L03N_2/VS2	T3	DUAL
2	IO_L03P_2/RDWR_B	R3	DUAL
2	IO_L04N_2/VS0	P5	DUAL
2	IO_L04P_2/VS1	N6	DUAL
2	IO_L05N_2	R5	I/O
2	IO_L05P_2	T4	I/O
2	IO_L06N_2/D6	T6	DUAL
2	IO_L06P_2/D7	T5	DUAL
2	IO_L08N_2/D4	N8	DUAL
2	IO_L08P_2/D5	P7	DUAL
2	IO_L09N_2/GCLK13	T7	GCLK
2	IO_L09P_2/GCLK12	R7	GCLK
2	IO_L10N_2/GCLK15	T8	GCLK
2	IO_L10P_2/GCLK14	P8	GCLK
2	IO_L11N_2/GCLK1	P9	GCLK
2	IO_L11P_2/GCLK0	N9	GCLK
2	IO_L12N_2/GCLK3	T9	GCLK
2	IO_L12P_2/GCLK2	R9	GCLK
2	IO_L14N_2/MOSI/CSI_B	P10	DUAL
2	IO_L14P_2	T10	I/O
2	IO_L15N_2/DOUT	R11	DUAL
2	IO_L15P_2/AWAKE	T11	PWRMGT

Table 69: Spartan-3A FT256 Pinout (XC3S700A,

Bank	XC3S700A XC3S1400A	FT256 Ball	Type
2	IO_L16N_2	N11	I/O
2	IO_L16P_2	P11	I/O
2	IO_L17N_2/D3	P12	DUAL
2	IO_L17P_2/INIT_B	T12	DUAL
2	IO_L18N_2/D1	R13	DUAL
2	IO_L18P_2/D2	T13	DUAL
2	IO_L19N_2	P13	I/O
2	IO_L19P_2	N12	I/O
2	IO_L20N_2/CCLK	R14	DUAL
2	IO_L20P_2/D0/DIN/MISO	T14	DUAL
2	IP_2/VREF_2	M11	VREF
2	IP_2/VREF_2	M7	VREF
2	IP_2/VREF_2	M9	VREF
2	IP_2/VREF_2	N5	VREF
2	IP_2/VREF_2	P6	VREF
2	VCCO_2	R12	VCCO
2	VCCO_2	R4	VCCO
2	VCCO_2	R8	VCCO
3	IO_L01N_3	C1	I/O
3	IO_L01P_3	C2	I/O
3	IO_L02N_3	D3	I/O
3	IO_L02P_3	D4	I/O
3	IO_L03N_3	E1	I/O
3	IO_L03P_3	D1	I/O
3	IO_L04N_3	F4	I/O
3	IO_L04P_3	E4	I/O
3	IO_L05N_3	E2	I/O
3	IO_L05P_3	E3	I/O
3	IO_L07N_3	G3	I/O
3	IO_L07P_3	F3	I/O
3	IO_L08N_3/VREF_3	G1	VREF
3	IO_L08P_3	F1	I/O
3	IO_L11N_3/LHCLK1	H1	LHCLK
3	IO_L11P_3/LHCLK0	G2	LHCLK
3	IO_L12N_3/IRDY2/LHCLK3	J3	LHCLK
3	IO_L12P_3/LHCLK2	H3	LHCLK
3	IO_L14N_3/LHCLK5	J1	LHCLK
3	IO_L14P_3/LHCLK4	J2	LHCLK
3	IO_L15N_3/LHCLK7	K1	LHCLK
3	IO_L15P_3/TRDY2/LHCLK6	K3	LHCLK

FG320: 320-ball Fine-pitch Ball Grid Array

The 320-ball fine-pitch ball grid array package, FG320, supports two Spartan-3A FPGAs, the XC3S200A and the XC3S400A, as shown in [Table 77](#) and [Figure 23](#).

The FG320 package is an 18 x 18 array of solder balls minus the four center balls.

[Table 77](#) lists all the package pins. They are sorted by bank number and then by pin name of the largest device. Pins that form a differential I/O pair appear together in the table. The table also shows the pin number for each pin and the pin type, as defined earlier.

The shaded rows indicate pinout differences between the XC3S200A and the XC3S400A FPGAs. The XC3S200A has three unconnected balls, indicated as N.C. (No Connection) in [Table 77](#) and with the black diamond character (◆) in [Table 77](#) and [Figure 23](#).

All other balls have nearly identical functionality on all three devices. [Table 80](#) summarizes the Spartan-3A FPGA footprint migration differences for the FG320 package.

An electronic version of this package pinout table and footprint diagram is available for download from the Xilinx website at

www.xilinx.com/support/documentation/data_sheets/s3a_pin.zip.

Pinout Table

Table 77: Spartan-3A FG320 Pinout

Bank	Pin Name	FG320 Ball	Type
0	IO_L01N_0	C15	I/O
0	IO_L01P_0	C16	I/O
0	IO_L02N_0	A16	I/O
0	IO_L02P_0/VREF_0	B16	VREF
0	IO_L03N_0	A14	I/O
0	IO_L03P_0	A15	I/O
0	IO_L04N_0	C14	I/O
0	IO_L04P_0	B15	I/O
0	IO_L05N_0	D12	I/O
0	IO_L05P_0	C13	I/O
0	IO_L06N_0/VREF_0	A13	VREF
0	IO_L06P_0	B13	I/O
0	IO_L07N_0	B12	I/O
0	IO_L07P_0	C12	I/O
0	IO_L08N_0	F11	I/O
0	IO_L08P_0	E11	I/O
0	IO_L09N_0	A11	I/O

Table 77: Spartan-3A FG320 Pinout(Continued)

Bank	Pin Name	FG320 Ball	Type
0	IO_L09P_0	B11	I/O
0	IO_L10N_0	D10	I/O
0	IO_L10P_0	C11	I/O
0	IO_L11N_0/GCLK5	C9	GCLK
0	IO_L11P_0/GCLK4	B10	GCLK
0	IO_L12N_0/GCLK7	B9	GCLK
0	IO_L12P_0/GCLK6	A10	GCLK
0	IO_L13N_0/GCLK9	B7	GCLK
0	IO_L13P_0/GCLK8	A8	GCLK
0	IO_L14N_0/GCLK11	C8	GCLK
0	IO_L14P_0/GCLK10	B8	GCLK
0	IO_L15N_0	C7	I/O
0	IO_L15P_0	D8	I/O
0	IO_L16N_0	E9	I/O
0	IO_L16P_0	D9	I/O
0	IO_L17N_0	B6	I/O
0	IO_L17P_0	A6	I/O
0	IO_L18N_0/VREF_0	A4	VREF
0	IO_L18P_0	A5	I/O
0	IO_L19N_0	E7	I/O
0	IO_L19P_0	F8	I/O
0	IO_L20N_0	D6	I/O
0	IO_L20P_0	C6	I/O
0	IO_L21N_0	A3	I/O
0	IO_L21P_0	B4	I/O
0	IO_L22N_0	D5	I/O
0	IO_L22P_0	C5	I/O
0	IO_L23N_0	A2	I/O
0	IO_L23P_0	B3	I/O
0	IO_L24N_0/PUDC_B	E5	DUAL
0	IO_L24P_0/VREF_0	E6	VREF
0	IP_0	D13	INPUT
0	IP_0	D14	INPUT
0	IP_0	E12	INPUT
0	XC3S400A: IP_0 XC3S200A: N.C. (◆)	E13	INPUT
0	IP_0	F7	INPUT
0	IP_0	F9	INPUT
0	IP_0	F10	INPUT

Table 77: Spartan-3A FG320 Pinout(Continued)

Bank	Pin Name	FG320 Ball	Type
3	IO_L10N_3/VREF_3	F1	VREF
3	IO_L10P_3	F2	I/O
3	IO_L11N_3	J6	I/O
3	IO_L11P_3	J7	I/O
3	IO_L13N_3	H1	I/O
3	IO_L13P_3	H2	I/O
3	IO_L14N_3/LHCLK1	J3	LHCLK
3	IO_L14P_3/LHCLK0	H3	LHCLK
3	IO_L15N_3/IRDY2/LHCLK3	J1	LHCLK
3	IO_L15P_3/LHCLK2	J2	LHCLK
3	IO_L17N_3/LHCLK5	K5	LHCLK
3	IO_L17P_3/LHCLK4	J4	LHCLK
3	IO_L18N_3/LHCLK7	K3	LHCLK
3	IO_L18P_3/TRDY2/LHCLK6	K2	LHCLK
3	IO_L19N_3	L2	I/O
3	IO_L19P_3/VREF_3	L1	VREF
3	IO_L21N_3	M2	I/O
3	IO_L21P_3	N1	I/O
3	IO_L22N_3	N2	I/O
3	IO_L22P_3	P1	I/O
3	IO_L23N_3	L4	I/O
3	IO_L23P_3	L3	I/O
3	IO_L25N_3	R2	I/O
3	IO_L25P_3	R1	I/O
3	IO_L26N_3	N4	I/O
3	IO_L26P_3	N3	I/O
3	IO_L27N_3	T2	I/O
3	IO_L27P_3	T1	I/O
3	IO_L29N_3	N6	I/O
3	IO_L29P_3	N5	I/O
3	IO_L30N_3	R3	I/O
3	IO_L30P_3	P3	I/O
3	IO_L31N_3	U2	I/O
3	IO_L31P_3	U1	I/O
3	IP_L04N_3/VREF_3	H7	VREF
3	IP_L04P_3	G6	INPUT
3	IP_L08N_3/VREF_3	H5	VREF
3	IP_L08P_3	H6	INPUT
3	IP_L12N_3	G2	INPUT
3	IP_L12P_3	G3	INPUT

Table 77: Spartan-3A FG320 Pinout(Continued)

Bank	Pin Name	FG320 Ball	Type
3	IP_L16N_3	K6	INPUT
3	IP_L16P_3	J5	INPUT
3	IP_L20N_3	L6	INPUT
3	IP_L20P_3	L7	INPUT
3	IP_L24N_3	M4	INPUT
3	IP_L24P_3	M3	INPUT
3	IP_L28N_3	M5	INPUT
3	IP_L28P_3	M6	INPUT
3	IP_L32N_3/VREF_3	P4	VREF
3	IP_L32P_3	P5	INPUT
3	VCCO_3	E2	VCCO
3	VCCO_3	H4	VCCO
3	VCCO_3	L5	VCCO
3	VCCO_3	P2	VCCO
GND	GND	A1	GND
GND	GND	A7	GND
GND	GND	A12	GND
GND	GND	A18	GND
GND	GND	C10	GND
GND	GND	D4	GND
GND	GND	D7	GND
GND	GND	D15	GND
GND	GND	F6	GND
GND	GND	G1	GND
GND	GND	G12	GND
GND	GND	G18	GND
GND	GND	H8	GND
GND	GND	H10	GND
GND	GND	J11	GND
GND	GND	J15	GND
GND	GND	K4	GND
GND	GND	K8	GND
GND	GND	L9	GND
GND	GND	L11	GND
GND	GND	M1	GND
GND	GND	M7	GND
GND	GND	M18	GND
GND	GND	N13	GND
GND	GND	R4	GND
GND	GND	R12	GND

FG320 Footprint

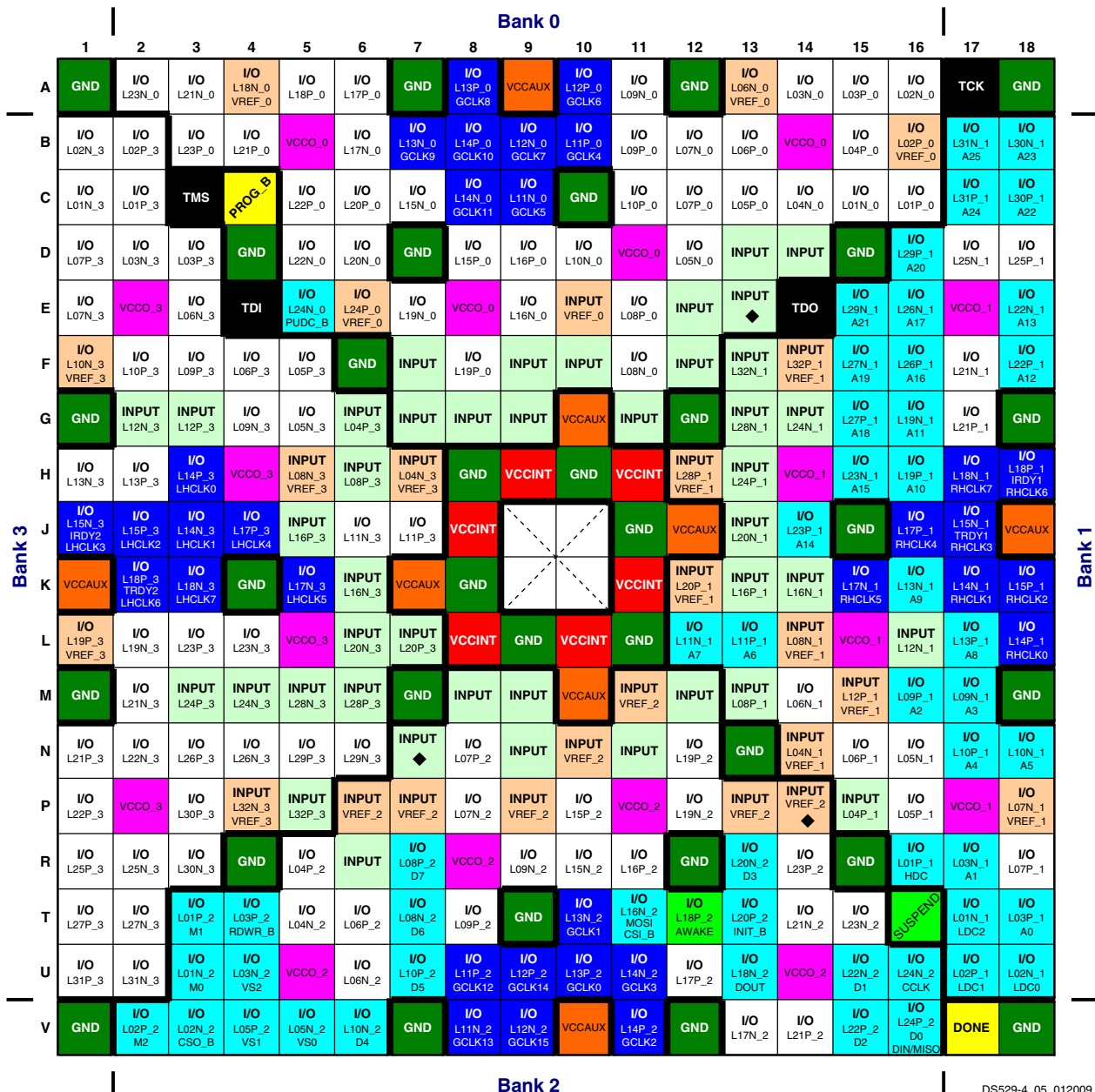


Figure 23: FG320 Package Footprint (Top View)

101	I/O: Unrestricted, general-purpose user I/O	51	DUAL: Configuration pins, then possible user-I/O	23 - 24	VREF: User I/O or input voltage reference for bank	2	SUSPEND: Dedicated SUSPEND and dual-purpose AWAKE Power Management pins
40 - 42	INPUT: Unrestricted, general-purpose input pin	32	CLK: User I/O, input, or global buffer input	16	VCCO: Output voltage supply for bank		
2	CONFIG: Dedicated configuration pins	4	JTAG: Dedicated JTAG port pins	6	VCCINT: Internal core supply voltage (+1.2V)		
3	N.C.: Not connected. Only the XC3S200A has these pins (◆).	32	GND: Ground	8	VCCAUX: Auxiliary supply voltage		

FG484: 484-ball Fine-pitch Ball Grid Array

The 484-ball fine-pitch ball grid array, FG484, supports both the XC3S700A and the XC3S1400A FPGAs. There are three pinout differences, as described in [Table 86](#).

[Table 83](#) lists all the FG484 package pins. They are sorted by bank number and then by pin name. Pairs of pins that form a differential I/O pair appear together in the table. The table also shows the pin number for each pin and the pin type, as defined earlier.

The shaded rows indicate pinout differences between the XC3S700A and the XC3S1400A FPGAs. The XC3S700A has three unconnected balls, indicated as N.C. (No Connection) in [Table 83](#) and with the black diamond character (◆) in [Table 83](#) and [Figure 25](#).

An electronic version of this package pinout table and footprint diagram is available for download from the Xilinx website at

www.xilinx.com/support/documentation/data_sheets/s3a_pin.zip.

Pinout Table

Table 83: Spartan-3A FG484 Pinout

Bank	Pin Name	FG484 Ball	Type
0	IO_L01N_0	D18	I/O
0	IO_L01P_0	E17	I/O
0	IO_L02N_0	C19	I/O
0	IO_L02P_0/VREF_0	D19	VREF
0	IO_L03N_0	A20	I/O
0	IO_L03P_0	B20	I/O
0	IO_L04N_0	F15	I/O
0	IO_L04P_0	E15	I/O
0	IO_L05N_0	A18	I/O
0	IO_L05P_0	C18	I/O
0	IO_L06N_0	A19	I/O
0	IO_L06P_0/VREF_0	B19	VREF
0	IO_L07N_0	C17	I/O
0	IO_L07P_0	D17	I/O
0	IO_L08N_0	C16	I/O
0	IO_L08P_0	D16	I/O
0	IO_L09N_0	E14	I/O
0	IO_L09P_0	C14	I/O
0	IO_L10N_0	A17	I/O
0	IO_L10P_0	B17	I/O
0	IO_L11N_0	C15	I/O

Table 83: Spartan-3A FG484 Pinout(Continued)

Bank	Pin Name	FG484 Ball	Type
0	IO_L11P_0	D15	I/O
0	IO_L12N_0/VREF_0	A15	VREF
0	IO_L12P_0	A16	I/O
0	IO_L13N_0	A14	I/O
0	IO_L13P_0	B15	I/O
0	IO_L14N_0	E13	I/O
0	IO_L14P_0	F13	I/O
0	IO_L15N_0	C13	I/O
0	IO_L15P_0	D13	I/O
0	IO_L16N_0	A13	I/O
0	IO_L16P_0	B13	I/O
0	IO_L17N_0/GCLK5	E12	GCLK
0	IO_L17P_0/GCLK4	C12	GCLK
0	IO_L18N_0/GCLK7	A11	GCLK
0	IO_L18P_0/GCLK6	A12	GCLK
0	IO_L19N_0/GCLK9	C11	GCLK
0	IO_L19P_0/GCLK8	B11	GCLK
0	IO_L20N_0/GCLK11	E11	GCLK
0	IO_L20P_0/GCLK10	D11	GCLK
0	IO_L21N_0	C10	I/O
0	IO_L21P_0	A10	I/O
0	IO_L22N_0	A8	I/O
0	IO_L22P_0	A9	I/O
0	IO_L23N_0	E10	I/O
0	IO_L23P_0	D10	I/O
0	IO_L24N_0/VREF_0	C9	VREF
0	IO_L24P_0	B9	I/O
0	IO_L25N_0	C8	I/O
0	IO_L25P_0	B8	I/O
0	IO_L26N_0	A6	I/O
0	IO_L26P_0	A7	I/O
0	IO_L27N_0	C7	I/O
0	IO_L27P_0	D7	I/O
0	IO_L28N_0	A5	I/O
0	IO_L28P_0	B6	I/O
0	IO_L29N_0	D6	I/O
0	IO_L29P_0	C6	I/O
0	IO_L30N_0	D8	I/O

Table 83: Spartan-3A FG484 Pinout(Continued)

Bank	Pin Name	FG484 Ball	Type
2	IO_L10P_2	Y7	I/O
2	IO_L11N_2/VS0	Y8	DUAL
2	IO_L11P_2/VS1	W8	DUAL
2	IO_L12N_2	AB8	I/O
2	IO_L12P_2	AA8	I/O
2	IO_L13N_2	Y10	I/O
2	IO_L13P_2	V10	I/O
2	IO_L14N_2/D6	AB9	DUAL
2	IO_L14P_2/D7	Y9	DUAL
2	IO_L15N_2	AB10	I/O
2	IO_L15P_2	AA10	I/O
2	IO_L16N_2/D4	AB11	DUAL
2	IO_L16P_2/D5	Y11	DUAL
2	IO_L17N_2/GCLK13	V11	GCLK
2	IO_L17P_2/GCLK12	U11	GCLK
2	IO_L18N_2/GCLK15	Y12	GCLK
2	IO_L18P_2/GCLK14	W12	GCLK
2	IO_L19N_2/GCLK1	AB12	GCLK
2	IO_L19P_2/GCLK0	AA12	GCLK
2	IO_L20N_2/GCLK3	U12	GCLK
2	IO_L20P_2/GCLK2	V12	GCLK
2	IO_L21N_2	Y13	I/O
2	IO_L21P_2	AB13	I/O
2	IO_L22N_2/MOSI/CSI_B	AB14	DUAL
2	IO_L22P_2	AA14	I/O
2	IO_L23N_2	Y14	I/O
2	IO_L23P_2	W13	I/O
2	IO_L24N_2/ DOUT	AA15	DUAL
2	IO_L24P_2/AWAKE	AB15	PWR MGMT
2	IO_L25N_2	Y15	I/O
2	IO_L25P_2	W15	I/O
2	IO_L26N_2/D3	U13	DUAL
2	IO_L26P_2/INIT_B	V13	DUAL
2	IO_L27N_2	Y16	I/O
2	IO_L27P_2	AB16	I/O
2	IO_L28N_2/D1	Y17	DUAL
2	IO_L28P_2/D2	AA17	DUAL
2	IO_L29N_2	AB18	I/O
2	IO_L29P_2	AB17	I/O

Table 83: Spartan-3A FG484 Pinout(Continued)

Bank	Pin Name	FG484 Ball	Type
2	IO_L30N_2	V15	I/O
2	IO_L30P_2	V14	I/O
2	IO_L31N_2	V16	I/O
2	IO_L31P_2	W16	I/O
2	IO_L32N_2	AA19	I/O
2	IO_L32P_2	AB19	I/O
2	IO_L33N_2	V17	I/O
2	IO_L33P_2	W18	I/O
2	IO_L34N_2	W17	I/O
2	IO_L34P_2	Y18	I/O
2	IO_L35N_2	AA21	I/O
2	IO_L35P_2	AB21	I/O
2	IO_L36N_2/CCLK	AA20	DUAL
2	IO_L36P_2/D0/DIN/MISO	AB20	DUAL
2	IP_2	P12	INPUT
2	IP_2	R10	INPUT
2	IP_2	R11	INPUT
2	IP_2	R9	INPUT
2	IP_2	T13	INPUT
2	IP_2	T14	INPUT
2	IP_2	T9	INPUT
2	IP_2	U10	INPUT
2	IP_2	U15	INPUT
2	XC3S1400A: IP_2 XC3S700A: N.C. (◆)	U16	INPUT
2	XC3S1400A: IP_2 XC3S700A: N.C. (◆)	U7	INPUT
2	IP_2	U8	INPUT
2	IP_2	V7	INPUT
2	IP_2/VREF_2	R12	VREF
2	IP_2/VREF_2	R13	VREF
2	IP_2/VREF_2	R14	VREF
2	IP_2/VREF_2	T10	VREF
2	IP_2/VREF_2	T11	VREF
2	IP_2/VREF_2	T15	VREF
2	IP_2/VREF_2	T16	VREF
2	IP_2/VREF_2	T7	VREF
2	XC3S1400A: IP_2/VREF_2 XC3S700A: N.C. (◆)	T8	VREF
2	IP_2/VREF_2	V8	VREF
2	VCCO_2	AA13	VCCO

FG676 Footprint

Left Half of FG676 Package (Top View)

313 I/O: Unrestricted, general-purpose user I/O

67 INPUT: Unrestricted, general-purpose input pin

51 DUAL: Configuration pins, then possible user I/O

2 SUSPEND: Dedicated SUSPEND and dual-purpose AWAKE Power Management pins

38 VREF: User I/O or input voltage reference for bank

32 CLK: User I/O, input, or clock buffer input

2 CONFIG: Dedicated configuration pins

4 JTAG: Dedicated JTAG port pins

77 GND: Ground

36 VCCO: Output voltage supply for bank

23 VCCINT: Internal core supply voltage (+1.2V)

14 VCCAUX: Auxiliary supply voltage

17 N.C.: Not connected

Bank 0													
	1	2	3	4	5	6	7	8	9	10	11	12	13
A	GND	PROG_B	I/O L51P_0	I/O L45P_0	INPUT	GND	INPUT	I/O L38P_0	I/O L36P_0	I/O L33P_0	GND	I/O L29P_0	INPUT
B	I/O L02N_3	I/O L02P_3	I/O L51N_0	I/O L45N_0	VCCO_0	I/O L41P_0	I/O L42P_0	I/O L38N_0	I/O L36N_0	I/O L33N_0	VCCO_0	I/O L29N_0	I/O L28P_0 GCLK10
C	INPUT L04N_3 VREF_3	INPUT L04P_3	GND	INPUT	I/O L44P_0	I/O L41N_0	I/O L42N_0	I/O L40P_0	GND	I/O L34P_0	I/O L32P_0	I/O L30N_0	I/O L28N_0 GCLK11
D	INPUT L08N_3	INPUT L08P_3	I/O L06P_3	TMS	N.C.	I/O L44N_0	INPUT VREF_0	I/O L40N_0	I/O L37N_0	I/O L34N_0	I/O L32N_0 VREF_0	INPUT	I/O L30P_0
E	I/O L11P_3	VCCO_3	I/O L07P_3	I/O L06N_3	VCCAUX	N.C.	I/O L48N_0	VCCO_0	N.C.	I/O L37P_0	INPUT	I/O L31P_0	VCCO_0
F	GND	I/O L11N_3	I/O L14N_3	I/O L07N_3	I/O L09P_3	GND	I/O L48P_0	I/O L52P_0 VREF_0	N.C.	INPUT	GND	I/O L31N_0	I/O L27P_0 GCLK8
G	INPUT L16N_3	INPUT L16P_3	I/O L14P_3	I/O L09N_3	INPUT L12P_3	I/O L03P_3	TDI	I/O L52N_0 PUDC_B	I/O L47P_0	I/O L46P_0	INPUT VREF_0	I/O L35P_0	I/O L27N_0 GCLK9
H	I/O L17N_3	I/O L17P_3	GND	INPUT L12N_3 VREF_3	VCCO_3	I/O L10N_3	I/O L03N_3	GND	I/O L47N_0	I/O L46N_0	VCCO_0	I/O L35N_0	INPUT
J	INPUT L24P_3	INPUT L20N_3 VREF_3	INPUT L20P_3	I/O L19N_3	I/O L19P_3	I/O L13N_3	I/O L10P_3	I/O L01P_3	I/O L01N_3	INPUT	I/O L43P_0	I/O L39P_0	INPUT
K	INPUT L24N_3	I/O L23N_3	I/O L23P_3	I/O L22N_3	I/O L22P_3	I/O L18P_3	I/O L13P_3	I/O L05N_3	I/O L05P_3	GND	I/O L43N_0	I/O L39N_0	VCCAUX
L	GND	VCCO_3	I/O L25N_3	I/O L25P_3	VCCAUX	GND	I/O L18N_3	VCCO_3	I/O L15N_3	I/O L15P_3	GND	VCCINT	GND
M	I/O L29N_3 VREF_3	I/O L29P_3	I/O L27N_3	I/O L27P_3	I/O L28P_3	I/O L28N_3	I/O L26N_3	I/O L26P_3	I/O L21N_3	I/O L21P_3	VCCINT	GND	VCCINT
N	I/O L31P_3	I/O L31N_3	GND	I/O L30N_3	I/O L30P_3	I/O L32P_3 LHCLK0	I/O L32N_3 LHCLK1	GND	I/O L35P_3 TRDY2 LHCLK6	VCCAUX	GND	VCCINT	VCCINT
P	I/O L33P_3 LHCLK2	I/O L33N_3 IRDY2 LHCLK3	I/O L34N_3 LHCLK5	I/O L34P_3 LHCLK4	VCCO_3	I/O L39N_3	I/O L39P_3	I/O L41P_3	I/O L41N_3	I/O L35N_3 LHCLK7	VCCINT	GND	VCCINT
R	I/O L36P_3 VREF_3	I/O L36N_3	I/O L37P_3	I/O L37N_3	I/O L40P_3	I/O L40N_3	I/O L45N_3	I/O L45P_3	I/O L43N_3	I/O L43P_3 VREF_3	GND	VCCINT	GND
T	GND	VCCO_3	I/O L38P_3	I/O L38N_3	I/O L42P_3	GND	I/O L51P_3	VCCO_3	I/O L48N_3	I/O L48P_3	VCCINT	GND	VCCINT
U	I/O L44P_3	I/O L44N_3	INPUT L46P_3	I/O L42N_3	I/O L49P_3	I/O L51N_3	I/O L56P_3	I/O L56N_3	I/O L61P_3	GND	I/O L13N_2	VCCINT	GND
V	I/O L47P_3	I/O L47N_3	GND	INPUT L46N_3	I/O L49N_3	I/O L59N_3	I/O L59P_3	I/O L61N_3	VCCAUX	I/O L09P_2	I/O L13P_2	I/O L16P_2	I/O L20P_2
W	INPUT L50P_3	INPUT L50N_3 VREF_3	I/O L52P_3	I/O L52N_3	VCCO_3	I/O L63N_3	I/O L63P_3	GND	I/O L05P_2	I/O L09N_2	VCCO_2	I/O L16N_2	I/O L20N_2
Y	I/O L53P_3	I/O L53N_3	INPUT L54P_3	INPUT L54N_3	I/O L57P_3	I/O L57N_3	I/O L02P_2 M2	N.C.	I/O L05N_2	I/O L12P_2	INPUT	I/O L17P_2 RDWR_B	I/O L25N_2 GCLK13
A	GND	I/O L55P_3	I/O L55N_3	INPUT L58P_3	INPUT L58N_3 VREF_3	GND	I/O L02N_2 CSO_B	N.C.	INPUT VREF_2	I/O L12N_2	GND	I/O L17N_2 VS2	I/O L25P_2 GCLK12
A	I/O L60P_3	VCCO_3	INPUT L62P_3	INPUT L62N_3	VCCAUX	INPUT VREF_2	I/O L14N_2	VCCO_2	I/O L15P_2	INPUT VREF_2	VCCAUX	I/O L21P_2	INPUT
A	I/O L60N_3	I/O L64P_3	I/O L64N_3	I/O L01P_2 M1	N.C.	I/O L08P_2	INPUT	I/O L14P_2	I/O L15N_2	INPUT VREF_2	I/O L23N_2	I/O L21N_2	INPUT
A	I/O L65P_3	I/O L65N_3	GND	I/O L01N_2 M0	N.C.	I/O L08N_2	I/O L11P_2	GND	INPUT	INPUT	I/O L23P_2	INPUT VREF_2	GND
A	INPUT L66P_3	INPUT L66N_3 VREF_3	I/O L06P_2	I/O L07P_2	VCCO_2	I/O L10N_2	I/O L11N_2	I/O L18P_2	I/O L19P_2 VS1	I/O L22P_2 D7	VCCO_2	I/O L24N_2 D4	I/O L26N_2 GCLK15
A	GND	INPUT	I/O L06N_2	I/O L07N_2	I/O L10P_2	GND	INPUT	I/O L18N_2	I/O L19N_2 VS0	I/O L22N_2 D6	GND	I/O L24P_2 D5	I/O L26P_2 GCLK14
Bank 2													

Figure 27: FG676 Package Footprint (Top View)

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Bank 0																									
14	15	16	17	18	19	20	21	22	23	24	25	26													
I/O L26N_0 GCLK7	I/O L23N_0	GND	INPUT	I/O L18N_0	I/O L15N_0	I/O L14N_0	GND	I/O L07N_0	INPUT	N.C. ◆	TCK	GND													
I/O L26P_0 GCLK6	I/O L23P_0	VCCO_0	I/O L19N_0	I/O L18P_0	I/O L15P_0	I/O L14P_0 VREF_0	I/O L09N_0	VCCO_0	I/O L07P_0	N.C. ◆	INPUT L65N_1	INPUT L65P_1 VREF_1													
GND	I/O L22N_0	I/O L21N_0	I/O L19P_0	I/O L17N_0	GND	I/O L11N_0	I/O L09P_0	I/O L05N_0	I/O L06N_0	GND	I/O L63N_1 A23	I/O L63P_1 A22													
INPUT VREF_0	INPUT	I/O L22P_0	I/O L21P_0	I/O L17P_0	INPUT	I/O L11P_0	I/O L10N_0	I/O L05P_0	I/O L06P_0	I/O L61N_1	I/O L61P_1	I/O L60N_1													
I/O L24P_0	I/O L20N_0 VREF_0	VCCAUX	I/O L13N_0	INPUT	VCCO_0	INPUT	I/O L10P_0	VCCAUX	TDO	I/O L56P_1	VCCO_1	I/O L60P_1													
I/O L24N_0	I/O L20P_0	GND	I/O L13P_0	N.C. ◆	I/O L02N_0	I/O L01N_0	GND	I/O L58P_1 VREF_1	I/O L56N_1	I/O L54N_1	I/O L54P_1	GND													
INPUT L16P_0	I/O L16N_0	INPUT	I/O L08N_0	N.C. ◆	I/O L02P_0 VREF_0	I/O L01P_0	I/O L64N_1 A25	I/O L58N_1	I/O L51P_1	I/O L51N_1	INPUT L52N_1 VREF_1	INPUT L52P_1													
GND	I/O L16N_0	VCCO_0	I/O L08P_0	INPUT	GND	I/O L64P_1 A24	I/O L62N_1 A21	VCCO_1	INPUT L48P_1	INPUT L48N_1	INPUT L44N_1	INPUT L44P_1 VREF_1													
I/O L25N_0 GCLK5	INPUT	I/O L12P_0	INPUT VREF_0	VCCAUX	I/O L59P_1	I/O L59N_1	I/O L62P_1 A20	I/O L49N_1	I/O L49P_1	GND	I/O L43N_1 A19	I/O L43P_1 A18													
I/O L25P_0 GCLK4	VCCINT	I/O L12N_0	GND	I/O L57N_1	I/O L57P_1	I/O L53N_1	I/O L50N_1	I/O L46N_1	I/O L46P_1	INPUT L40P_1	I/O L41P_1	I/O L41N_1													
VCCINT	GND	VCCINT	I/O L55N_1	I/O L55P_1	VCCO_1	I/O L53P_1	GND	I/O L50P_1	INPUT L40N_1	I/O L38P_1 A12	VCCO_1	GND													
GND	VCCINT	GND	VCCINT	I/O L47N_1	I/O L47P_1	I/O L42N_1 A17	I/O L45P_1	I/O L45N_1	I/O L38N_1 A13	INPUT L36P_1 VREF_1	I/O L35N_1 A11	I/O L35P_1 A10													
VCCINT	GND	VCCINT	I/O L39N_1 A15	I/O L39P_1 A14	I/O L34N_1 RHCLK7	I/O L42P_1 A16	I/O L37N_1	VCCO_1	INPUT L36N_1	I/O L33N_1 RHCLK5	INPUT L32N_1	INPUT L32P_1													
VCCINT	VCCINT	GND	VCCAUX	I/O L34P_1 TRDY1 RHCLK6	GND	I/O L30N_1 RHCLK1	I/O L30P_1 RHCLK0	I/O L37P_1	I/O L33P_1 RHCLK4	GND	I/O L31N_1 TRDY1 RHCLK3	I/O L31P_1 RHCLK2													
VCCINT	GND	VCCINT	I/O L27N_1 A7	I/O L27P_1 A6	I/O L22P_1	I/O L22N_1	I/O L25P_1 A2	I/O L25N_1 A3	INPUT L28P_1 VREF_1	INPUT L28N_1	I/O L29P_1 A8	I/O L29N_1 A9													
GND	VCCINT	GND	I/O L17N_1	I/O L17P_1	VCCO_1	I/O L14N_1	GND	VCCAUX	I/O L26P_1 A4	I/O L26N_1 A5	VCCO_1	GND													
VCCAUX	I/O L35N_2	I/O L42N_2	GND	I/O L12N_1	I/O L12P_1	I/O L10N_1	I/O L14P_1	I/O L21N_1	I/O L23P_1	I/O L23N_1 VREF_1	INPUT L24P_1	INPUT L24N_1 VREF_1													
I/O L31P_2	I/O L35P_2	I/O L42P_2	I/O L46N_2	I/O L08P_1	I/O L08N_1	SUSPEND	I/O L10P_1	I/O L18N_1	I/O L21P_1	I/O L19P_1	I/O L19N_1	INPUT L20N_1 VREF_1													
GND	I/O L31N_2	VCCO_2	I/O L46P_2	N.C. ◆	GND	I/O L04P_1	I/O L04N_1	VCCO_1	I/O L18P_1	GND	INPUT L16P_1	INPUT L20P_1													
I/O L27P_2 GCLK0	I/O L34N_2 D3	INPUT 2 VREF_2	I/O L43N_2	N.C. ◆	N.C. ◆	I/O L01P_1 HDC	I/O L01N_1 LDC2	I/O L13P_1	I/O L13N_1	I/O L15P_1	I/O L15N_1	INPUT L16N_1													
I/O L27N_2 GCLK1	I/O L34P_2 INIT_B	GND	I/O L43P_2	I/O L47N_2	INPUT	INPUT VREF_2	GND	I/O L09P_1	I/O L09N_1	I/O L11P_1	I/O L11N_1	GND													
VCCO_2	I/O L30N_2 MOSI CSI_B	I/O L38N_2	INPUT	I/O L47P_2	VCCO_2	INPUT	DONE	VCCAUX	I/O L07P_1	I/O L07N_1 VREF_1	VCCO_1	I/O L06N_1													
I/O L29N_2	I/O L30P_2	I/O L38P_2	INPUT	INPUT	I/O L40N_2	I/O L41N_2	I/O L45N_2	N.C. ◆	I/O L03P_1 A0	I/O L03N_1 A1	I/O L05N_1	I/O L06P_1													
I/O L29P_2	I/O L32P_2 AWAKE	INPUT	I/O L33N_2	GND	I/O L40P_2	I/O L41P_2	I/O L44N_2	I/O L45P_2	N.C. ◆	GND	I/O L02N_1 LDC0	I/O L05P_1													
I/O L28N_2 GCLK3	I/O L32N_2 DDOUT	VCCO_2	I/O L33P_2	I/O L36N_2 D1	I/O L37N_2	I/O L39N_2	I/O L44P_2	VCCO_2	I/O L48N_2	I/O L52N_2 CCLK	I/O L51N_2	I/O L02P_1 LDC1													
I/O L28P_2 GCLK2	INPUT VREF_2	GND	INPUT VREF_2	I/O L36P_2 D2	I/O L37P_2	I/O L39P_2	GND	INPUT VREF_2	I/O L48P_2	I/O L52P_2 D0 DIN/MISO	I/O L51P_2	GND													
Bank 2																									

Right Half of FG676
Package (Top View)

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